

### **DURAVER-E-Cu Quality DE104 KF Laminate and Prepreg**

Tracking can easily occur in a damp, dusty or corrosive environments such as in dishwashers and washing machines. **DE104 KF**, with high tracking resistance (CTI 400), is ideal for such circuit board applications. The Underwriters' Laboratories Standard

Tracking resistant prepreg is available for multilayer Printed Wiring Board (PWB) applications.

for Safety (UL-94) has rated this product V-0 for flammability.

The product is listed as FR-4 and can be processed using standard parameters. DE104 KF multilayer (ML) corresponds to NEMA-grade FR-4 and meets the requirements of IPC-4104C /21.

### **ORDERING INFORMATION:**

Contact your local sales representative or visit www.isola-group.com for further information.

Isola Group 3100 West Ray Road Suite 301 Chandler, AZ 85226 Phone: 480-893-6527 Fax: 480-893-1409 info@isola-group.com info.hkg@isola-group.com

Isola Asia Pacific (Hong Kong) Ltd. Unit 3512 - 3522, 35/F No. 1 Hung To Road, Kwun Tong, Kowloon, Hong Kong Phone: 852-2418-1318 Fax: 852-2418-1533

Isola GmbH Isolastrasse 2 52353 Düren, Germany Phone: 49-2421-8080 Fax: 49-2421-80880 info-dur@isola-group.com

## **DE104 KF**

**Data Sheet** 

Tg 135, Td 315 Dk 4.00, Df 0.022 /21

#### **Features**

- High Thermal Performance
  - ▶ Tg: 135°C (DSC)
  - ► Td: 315°C (TGA @ 5% wt loss)
- RoHS Compliant
- UV Blocking and AOI Fluorescence
  - High throughput and accuracy during PCB fabrication and assembly
- Standard Availability
  - ► Thickness: 0.002" (0.05 mm) to 0.093" (2.4 mm)
  - Available in sheet or panel form
- Prepreg Standard Availability
  - ▶ Roll or panel form
  - Tooling of prepreg panels available
- Copper Foil Type Availability
  - Standard HTE Grade 3
- Copper Weights
  - ½, 1 and 2 oz (18, 35 and 70 μm) available
  - ► Heavier copper available upon request
  - ► Thinner copper foil available upon request
- Glass Fabric Availability
  - Standard E-glass
  - Square weave glass fabric available
  - Spread glass fabric available
- Industry Approvals
  - ▶ IPC-4101C /21
  - ▶ UL File Number E41625
  - Qualified to UL's MCIL Program

# **DE104 KF Specifications**

|  |   |   | Typical Values                                  |                      |                             |  |
|--|---|---|---|----------------------|-----------------------------|--|
| Property   |   |   |   | Units                | Test Method                 |  |
|  |   | Typical<br>Value                                | Specification                                   | Metric<br>(English)  | IPC-TM-650<br>(or as noted) |  |
| Glass Transition Temperature (Tg) by DSC   |   | 135   | 110-150   | °C                   | 2.4.25                      |  |
| Decomposition Temperature (Td) by TGA @ 5% weight loss   |   | 315   | -   | °C                   | ASTM D3850                  |  |
| T260   |   | 12  | _   | Minutes              | 2.4.25                      |  |
| T288   |   | -   | _   | Minutes              | 2.4.25                      |  |
| CTE, Z-axis  | A. Pre-Tg<br>B. Post-Tg   | 45<br>230                                       | -<br>-  | ppm/°C               | 2.4.24                      |  |
| CTE, X-, Y-axes  | A. Pre-Tg<br>B. Post-Tg   | 16/13<br>14/7                                   | -<br>-  | ppm/°C               | 2.4.24                      |  |
| Z-axis Expansion (50-260°C)  |   | _   | -   | %                    | 2.4.24                      |  |
| Thermal Conductivity   |   | _   | -   | W/mK                 | ASTM D5930                  |  |
| Thermal Stress @ 288°C (550.4°F)   | A. Unetched<br>B. Etched  | ≥10<br>≥10                                      | ≥10<br>≥10                                      | Seconds              | 2.4.13.1                    |  |
| Dk, Permittivity @ 1 MHz (Laminate & prepreg as laminated)<br>Split Post Method, Tested at 50% resin |   | 4.6-4.9   | 5.40  | -                    | 2.5.5.3                     |  |
| Df, Loss Tangent @ 1 MHz (Laminate & prepreg as laminated)<br>Split Post Method, Tested at 50% resin |   | 0.020   | 0.035   | _                    | 2.5.5.3                     |  |
| Volume Resistivity   | A. 96/35/90 B. After moisture resistance C. At elevated temperature   | -<br>1.0x10 <sup>8</sup><br>1.0x10 <sup>6</sup> | -<br>1.0x10 <sup>6</sup><br>1.0x10 <sup>3</sup> | MΩ-cm                | 2.5.17.1                    |  |
| Surface Resistivity  | A. 96/35/90 B. After moisture resistance C. At elevated temperature   | -<br>1.0x10 <sup>6</sup><br>1.0x10 <sup>4</sup> | -<br>1.0x10 <sup>4</sup><br>1.0x10 <sup>3</sup> | ΜΩ                   | 2.5.17.1                    |  |
| Dielectric Breakdown   |   | 45  | 40  | kV                   | 2.5.6                       |  |
| Arc Resistance   |   | _   | 60  | Seconds              | 2.5.1                       |  |
| Electric Strength (Laminate & prepreg as laminated)  |   | 39  | -   | kV/mm<br>(V/mil)     | 2.5.6.2                     |  |
| Comparative Tracking Index (CTI)   |   | 400   | -   | Class (Volts)        | -                           |  |
| Peel Strength  | A. Low profile copper foil and very low profile – all copper weights >17 microns     B. Standard profile copper | -   | 0.70 (4.0)                                      | N/mm<br>(lb/inch)    | 2.4.8                       |  |
|  | 1. After thermal stress 2. At 125°C (257°F) 3. After process solutions  | 1.80<br>1.60<br>1.8                             | 1.05 (6.0)<br>0.70 (4.0)<br>0.80 (4.5)          |                      | 2.4.8.2<br>2.4.8.3<br>—     |  |
| Flexural Strength  | A. Lengthwise direction B. Crosswise direction  | 580<br>460                                      | 415<br>345                                      | lb/inch²             | 2.4.4                       |  |
| Tensile Strength   | A. Lengthwise direction B. Crosswise direction  | -   | -   | lb/inch <sup>2</sup> | -                           |  |
| Moisture Absorption  |   | 0.13  | 0.8   | %                    | 2.6.2.1                     |  |
| Flammability (Laminate & prepreg as laminated)   |   | V-0   | V-1   | Rating               | UL 94                       |  |
| Max Operating Temperature  |   | _   | UL Cert   | °C                   | _                           |  |

The data, while believed to be accurate and based on analytical methods considered to be reliable, is for information purposes only. Any sales of these products will be governed by the terms and conditions of the agreement under which they are sold.

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